

## Design a Multiplier Using D.L Technique

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**ABSTRACT:** *This paper presents the design a dual logic level [D.L] multiplier for 32\*32 bit number multiplication. Modern computer system is a dedicated and very high speed unique multiplier. Therefore, this paper presents the design a dual logic level multiplier. The proposed system generates M,N and interconnected blocks. By extending bit of the operands and generating an additional product the dual logic level multiplier is obtained. Multiplication operation is performed by the dual logic level is efficient with the less area and it reduces delay i.e., speed is increased.*

**Keywords:** D.L, partial products, dual level logic unit.

### INTRODUCTION

Multiplication is a fundamental operation in most signal processing algorithms. Multipliers have large area, long latency and consume considerable power. Therefore low-power multiplier design has been an important part in low-power VLSI system design. There has been extensive work on low-power multipliers at technology, physical, circuit and logic levels. A system's performance is generally

Furthermore, it is generally the most area consuming. Hence, optimizing the speed and area of the multiplier is a major design issue. However, area and speed are usually conflicting constraints so that improving speed results mostly in larger areas. As a result, a whole spectrum of multipliers with different area-speed constraints has been designed with fully parallel.

The high speed multipliers and pipelined multipliers are used for digital signal processing (DSP) applications such as for multimedia and communication systems. High speed DSP computation applications such as Fast Fourier transform (FFT) require additions and multiplications. The conventional modified Booth encoding (MBE) generates an irregular partial product array because of the extra partial product bit at the least significant bit position of each partial product row. Therefore papers [4] presents a simple approach to generate a regular partial product array with fewer partial product rows and negligible overhead, thereby lowering the complexity of partial product reduction and reducing the area, delay, and power of MBE multipliers.

But the drawback of this multiplier is that it function only for signed number operands.

A column-bypassing multiplier is an improvement on the normal array multiplier (AM). The multiplier array consists of  $(n-1)$  rows of carry save adder (CSA), in which each row contains  $(n-1)$  full adder (FA) cells. Each FA in the CSA array has two outputs: 1) the sum bit goes down and 2) the carry bit goes to the lower left FA. The last row is a ripple adder for carry propagation.

PROPOSED SYSTEM:

The gates in the dual logic level [D.L] multiplier are always active regard of input logics. In, dual logic level [D.L] multiplier design is proposed in which the operations are disabled if the corresponding bit in the multiplicand is 0. Fig. 1 shows a  $N \times N$  dual logic level [D.L] multiplier, it can be seen that the  $M_0, M_1, \dots, M_n$  done their operations and the outputs are passed to interconnected

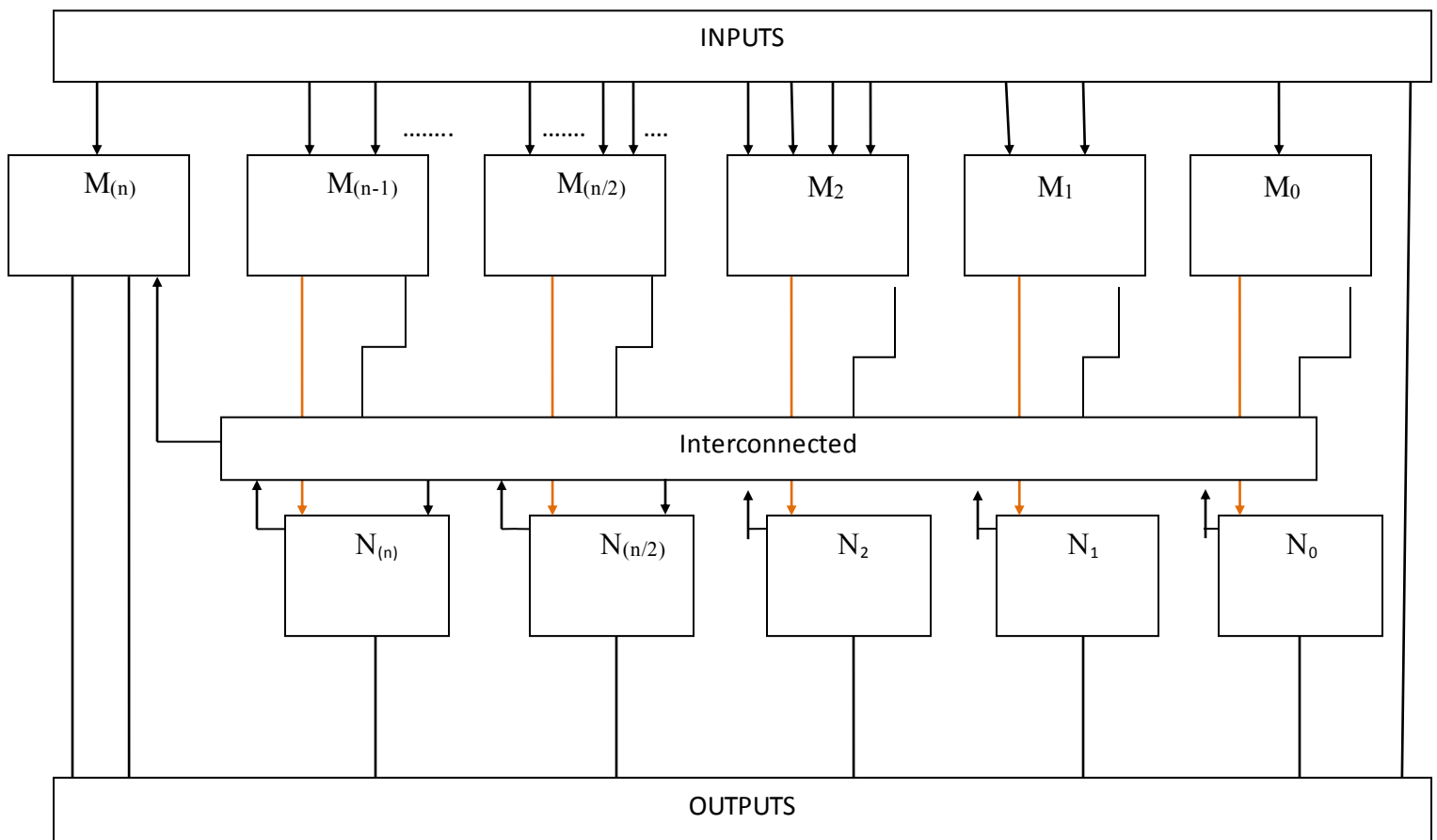


Fig. 1 4 x 4 HIGH PERFORMANCE DUAL LOGIC LEVEL MULTIPLIER

Block and N-Block simultaneously. Depends on the preference of operation the dual level logic gives the N-block output to interconnected block and vice versa.

Therefore, the output of the adders in both diagonals is 0, and the output sum bit is simply equal to the third bit. The above fig. 1 shows the 4\*4 high performance dual logic level multiplier reduced the timing waste occurring in traditional circuits that use the critical path cycle as an execution cycle period. The basic concept is to execute a shorter path using dual logic. Since most paths execute in a cycle period that is much smaller than the critical path delay. The same architecture is extended up to 32\*32 bits.

FIG 2 shows the sub block of fig 1 and it consists of gate level logic.

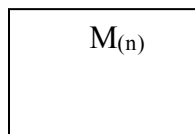


Fig 2 sub block

Dual logic level widely been adopted in multipliers since it can reduce the number of partial product rows to be added, thus reducing the size and enhancing the speed of the reduction tree. The least significant bit position of each partial product row encoding, leading to an irregular partial product array and a complex reduction tree. Therefore, the dual logic level multipliers with partial product array produce a very highspeed.

fig. 3 shows the technical schematic one of the LUT block of high performance dual logic level multiplier.

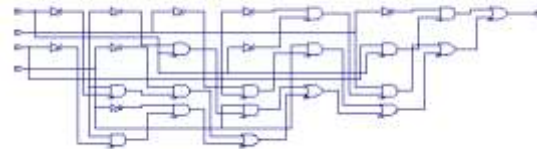


Fig. 3 LUT in technical Schematic

The below figure 4 shows the output waveform of 32\*32 bit dual logic level multiplier.



Fig. 4 OUTPUT Waveforms

The below table 1 shows the comparison of existed system and proposed system with area and delay

System/parameter	Area[kb]	Delay[ns]
Existed System	382256	410
Proposed system	283562	128

Table.1 comparison table

The above comparison table shows that area of the proposed system is less than existed system and delay is also efficient.

## CONCLUSION

The proposed system generates M, N and interconnected block. The each block consists of gates and the row in the architecture is lesser than existed multiplier. By generating an product with dual logic level multiplier is obtained. Multiplication operation is performed by the dual logic level unit is better performance than existed multiplier. The required hardware and the chip memory reduces and it reduces delay i.e., speed is increased.

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